Electronic Patent Application Fee Transmittal								
Application Number:	10778030							
Filing Date:	17	17-Feb-2004						
Title of Invention:	LSI PACKAGE PROVIDED WITH INTERFACE MODULE AND METHOD OF MOUNTING THE SAME							
First Named Inventor/Applicant Name:	Hii	Hiroshi Hamasaki						
Filer:	Ma	Marvin Jay Spivak/Mimi Chanthaphone						
Attorney Docket Number:	24	249025US2SRD						
Filed as Large Entity								
Utility Filing Fees								
Description		Fee Code	Quantity	Amount	Sub-Total in USD(\$)			
Basic Filing:								
Pages:								
Claims:								
Miscellaneous-Filing:								
Petition:								
Patent-Appeals-and-Interference:								
Post-Allowance-and-Post-Issuance:								
Utility Appl issue fee		1501	1	1440	1440			
Publ. Fee- early, voluntary, or normal		1504	1	300	300			

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Extension-of-Time:				
Miscellaneous:				
Printed copy of patent - no color	8001	1	3	3
	Tota	(\$)	1743	